LOW POWER-LOSS VOLTAGE REGULATORS / **REG** SURFACE MOUNT TYPE LOW POWER-LOSS VOLTAGE REGULATORS

Low Power-Loss Voltage Regulators

•TO-220 Type

		Absolu	ute max	kimum I	ratings	Electrica	l characte	eristics		Built-	in func	tions								
Model No.	Features	Output current Io	Input voltage Vin	Po dissip (V	wer bation V)	Output voltage Vo*3	Output voltage precision	Dropout voltage VI-O ^{*5}	at on	rrent on	⁼ control	sipation at OFF state	e output	rming e	Pack	age				
		(A)	(V)	Pd*1	Pd*2	(V) TYP.	(%)	(V)	Overhe	Overcul	ON/OFI	Low dis current	Variable voltage	Lead fo availabl		Package shape type ^{*7}				
PQxxxRDA1SZH series	ASO protection function,	1	24	1.4	45	3.3, 5, 9, 12	±3	0.5	0	0	0	0				A				
PQxxxRDA2SZH series	OFF state (lqs: 5 µA (MAX.))	2	20	1.4	15	3.3, 5, 9, 12	±2.5	1.0	0	0	0	0				A				
PQ30RV11J00H		1		1 5	15				0	0	∆*6		0	0	TO-220	В				
PQ30RV21J00H	Variable output voltage	2	35	1.5	18	1.5 to 30	1.5 to 30	1.5 to 30	1.5 to 30	1.5 to 30	±2*4	0.5	0	0	∆*6		0	0		В
PQ30RV31J00H		3		2	20				0	0	∆*6		0	0		В				

*1 At self-cooling

*2 With infinite heat sink attached

*3 The xxx in the model No. refer to the output voltage values of the model (e.g. 050 for 5 V, 120 for 12 V, 015 for 1.5 V).

*4 Reference voltage precision
*5 Current ratings are defined individually. *6 \triangle : Available by adding circuit

*7 Refer to page 35

■Surface Mount Type Low Power-Loss Voltage Regulators

●SOT-89 Type

SOT-89 Type												(Ta = 25°C)
		Abso	lute max ratings	imum	Electrical	character	istics		Built-	in fund	ctions		
Model No.	Features	Output current Io (A)	Input voltage Vin (V)	Power dissipa- tion Pd ^{*1} (W)	Output voltage Vo*2 (V) TYP.	Output voltage precision (%)	Dropout voltage VI-O ^{*3} (V)	Overheat protection	Overcurrent protection	ON/OFF control	Low dissipation current at OFF state	Variable output voltage	Package
PQ1LAxx5MSPQ	Compact, high radiation package, ceramic capacitor compatible	0.5	15	0.0	1.2, 1.5, 1.8, 2.5, 3.3, 5.0	±2.0	0.7	0	0	0	0		SOT 90
PQ1LAX95MSPQ	Ceramic capacitor compatible, variable output voltage	0.5	15	0.9	1.5 to 9.0	±2.0*4	0.7	0	0	0	0	0	301-89

*1 When mounted on a board

*2 The xx in the model No. refer to the output voltage values of the model (e.g. 25 for 2.5 V, 50 for 5.0 V).

*3 Current ratings are defined individually.

*4 Reference voltage precision

RoHS

(Ta = 25°C)

SURFACE MOUNT TYPE LOW POWER-LOSS VOLTAGE REGULATORS

SC-63 Type (1) Output Voltage Fixed Type

		Abs	olut	e ma	aximum	ratings	Electrica	l charac	teristics		Built-i	in fund	ctions				
Model No.	Features	C	utpu urrei Io (A)	ut ht	Input voltage	Power dissi-	Output voltage Vo*2	Output voltage	Dropout voltage		ent r	control	pation OFF state	output	ckage	Pack	age
		0.5	1	1.5	Vin (V)	Pd ^{*1} (W)	(V) TYP.	sion (%)	(V)	Overheat protectior	Overcurre	ON/OFF	Low dissi current at	Variable over the contrage of	Taped pa		Package shape type*4
PQxxxDNA1ZPH series	Ceramic capacitor compatible, ASO protection function, low dissipation current at OFF state (lqs: 5 μ A (MAX.)), solder dip compatible lead shape		0		24	8	3.3, 5, 9, 12	±2.5	0.5	0	0	0	0	-	0		F
PQxxxENA1ZPH series			0			8	1.5, 1.8, 2.5, 3.3			0	0	0	0	-	0		F
PQxxxENB1ZPH series	Minimum operating input voltage: 2.35 V, ceramic capacitor compatible, solder din compatible lead shape		0		10	5	1.2, 1.5, 1.8, 2.5, 3.3	±2.0	0.3	0	0	0	0	-	0	SC-63	F
PQxxxENAHZPH series				0			1.5, 1.8, 2.5, 3.3		0.9	0	0	0	0	-	0		F
PQxxxGN01ZPH series	Minimum operating input voltage: 1.7 V (Dual power supply type),		0		5.5	8	10 12	±30		0	0			Ι	0		F
PQxxxGN1HZPH series	ceramic capacitor compatible, solder dip compatible lead shape			0	5.5		1.0, 1.2	mV	_	0	0			_	0		F

*1 With infinite heat sink attached

*2 The xxx in the model No. refer to the output voltage values of the model (e.g. 033 for 3.3 V, 050 for 5 V, 120 for 12 V).

*3 Current ratings are defined individually.

*4 Refer to page 35

SC-63 Type (2) Output Voltage Variable Type

Absolute maximum ratings Electrical characteristics **Built-in functions** Output state Package current Output Output Low dissipation current at OFF s' Powe **ON/OFF** control Variable output voltage Taped package Input Dropout lo voltage voltage dissi-Model No. Features voltage VI-0*3 (A) voltage Overcurrent protection pation Vo preci-Overheat protection Vin Pd*1 (V) sion Package (V) (V) (W) ΤΎΡ. (%) 0.5 1 1.5 shape type*4 0 0 F PQ070XNA1ZPH 0 0.5 0 0 0 Minimum operating input voltage: PQ070XNAHZPH 0.9 0 0 \bigcirc 0 0 F 8 1.5 to 7 2.35 V. ±2.0*2 10 ceramic capacitor compatible, PQ070XNA2ZPH 0 F 0.5 0 0 0 0 0 solder dip compatible lead shape (2 A) 0 F PQ070XNB1ZPH 5 1.2 to 7 0.3 Reference voltage (Vref): 0.6 V, 0 0 F PQ035ZN01ZPH 0 0 0 _ minimum operating input voltage: 0.8 to ±30 1.7 V (Dual power supply type), 5.5 3.5 mV ceramic capacitor compatible, F PQ035ZN1HZPH 0 0 0 0 \bigcirc SC-63 solder dip compatible lead shape 8 Minimum operating input voltage: 3.5 V, ASO protection function, low dissipation current at OFF 3.0 to PQ200WNA1ZPH F state (Iqs: 5 µA (MAX.)), 20 ceramic capacitor compatible, solder dip compatible lead shape 24 ±2.5*2 0.5 Minimum operating input voltage: 5.5 V, low dissipation current at OFF 5.0 to F PQ200WN3MZPH 6.8 0 \bigcirc \bigcirc state (Iqs: 5 µA (MAX.)), (0.3) 20 ceramic capacitor compatible, current limit: 800 mA

*1 With infinite heat sink attached

Reference voltage precision

*2 *3 Current ratings are defined individually

*4 Refer to page 35

Notice

Notice In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that may occur in equipment using any SHARP devices shown in catalogs, data books, etc. Except where specially indicated, models listed on this page comply with the RoHS Directive*. For details, please contact SHARP. "RoHS Directive: Prohibits use of lead, cadmium, hexavalent chromium, mercury and specific brominated flame retardants (PBBs and PBDEs), with certain exceptions. Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device.



(Ta = 25°C)

(Ta = 25°C)

SURFACE MOUNT TYPE LOW POWER-LOSS VOLTAGE REGULATORS / SURFACE MOUNT TYPE CHOPPER REGULATORS

SOP-8 Type

●SOP-8 Type										(Ta = 25°C)
		Absolu	te maximum	ratings	Electrical charact	teristics	Built-in f	unctions	ge	
Model No.	Features	Output current Io (A)	Input voltage Vin (V)	Power dissipation Pd ^{*1} (W)	Output voltage Vo (V) TYP.	Output voltage precision*2 (mV)	Overheat protection	Overcurrent protection	Taped packaç	Package
PQ1DX095MZPQ	Built-in sink source function (For DDR II memory)	±0.8	6	0.6	Vdd x 1/2 (Vddq: 1.5 V (MIN.))	±25	0	0	0	SOP-8

*1 When mounted on a board *2 Reference voltage precision

■Surface Mount Type Chopper Regulators (DC-DC Converters)

(Ta = 25°C)

RoHS

		Abs maximu	solute ım ratings		Electrical	charact	eristics		Pacl	kage
Model No.	Features	Switch- ing current Isw (A)	Power dissipa- tion Pd ^{*1} (W)	Input voltage range Vin (V)	Output voltage*2 Vo (V)	Output type	Oscillation frequency fo (Hz) TYP.	Output saturation voltage Vsat (V) TYP.		Outline shape type*4
PQ6CU12X2APQ	High switching voltage: 40 V (MAX.) For tuner power supply Variable oscillation frequency Ceramic capacitor compatible	0.25	0.35	3.0 to 5.5	up to 36	Step- up	300 k to 800 k	Ron TYP. 1.7Ω	SOT-23	8-6W
PQ1CN38M2ZPH	PWM chopper regulator (high oscillation frequency) Output ON/OFF control function Overcurrent/overheat protection circuits For light load	0.8	8	4.5 to 40	VREF ^{*3} to 35 (step-down type)/ –VREF to –30	Step- down	300 k	0.9	SC-63	F
PQ1CN41H2ZPH	PWM chopper regulator (high oscillation frequency) Overcurrent/overheat protection circuits	1.5	8		(inverting type)	Step- down	300 k	0.9		F
PQ1CX41H2ZPQ	Bootstrap system for high efficiency (Efficiency 90% (TYP.)) Low voltage output: 0.8 V (MIN.) Ceramic capacitor compatible	1.5	0.8 When mounted on board	4.75 to 27	0.8 to 20	Step- down	400 k	RDSon TYP. 0.45Ω	SOP-8	
PQ1CX53H2MPQ	 Bootstrap system for high efficiency (Efficiency 89% (TYP.)) Low voltage output: 0.8 V (MIN.) Ceramic capacitor compatible 	3.5	2 When mounted on board	4.75 to 27	0.8 to 16	Step- down	400 k	RDSon TYP. 0.15Ω	USB-8	
PQ1CX61H1ZPQ	Bootstrap system for high efficiency (Efficiency 88% (TYP.)) Low voltage output: 1.0 V (MIN.) Ceramic capacitor compatible	1.5	0.8 When mounted on board	4.75 to 28	1.0 to 18.9	Step- down	900 k	RDSon TYP. 0.55Ω	SOP-8	

*1 With infinite heat sink attached or when mounted on a board listed in the specification sheets.

*2 Output variable ra *3 VREF nearly equal *4 Refer to page 35 Output variable range (step-down/inversion).

VREF nearly equal to 1.26 V

Chopper Regulators (DC-DC Converters)

RoHS

●TO-220 Type	9								(Ta	= 25°C)
		Abs maximu	olute m ratings		Electrical	characte	eristics		Pack	age
Model No.	Features	Switch- ing current Isw (A)	Power dissipa- tion Pd ^{*1} (W)	Input voltage range Vin (V)	Output voltage Vo*2 (V)	Output type	Oscillation frequency fo (kHz) TYP.	Output saturation voltage Vsat (V) TYP.		Outline shape type*5
PQ1CG21H2FZH	PWM chopper regulator Built-in overcurrent/overheat protection circuits Output ON/OFF control function						100	1.0		E
PQ1CG41H2FZH	PWM chopper regulator (high oscillation frequency) Built-in overcurrent/overheat protection circuits Output ON/OFF control function	1.5 ^{*3}	14	10	VREF ^{*4} to 35 (step-down type)/	Step-	300	1.0	TO 000	E
PQ1CG2032FZH	PWM chopper regulator Built-in overcurrent/overheat protection circuits Output ON/OFF control function		14	40	-VREF ^{*4} to -30 (inverting type)	down	70		10-220	E
PQ1CG3032FZH	PWM chopper regulator (high oscillation frequency) Built-in overcurrent/overheat protection circuits Output ON/OFF control function	3.5 ^{*3}					150	1.4		E

*1 With infinite heat sink attached *2 Output voltage variable range
*3 Peak current
*4 VREF nearly equal to 1.26 V (TYP.)
*5 Refer to page 35

Analog

LED DRIVERS

☆New product



■LED Drivers

•Built-in Step-up Circuit (1)

Model No.	Function	Features	No. of output circuits	Number of LEDs	Booster method	Constant current circuit	Switching transistor	Input voltage range (V)	Output*3 current (mA) MAX.	Oscillation frequency (Hz) TYP.	Package
PQ6CB11X1CP▲		High voltage CMOS output: 30 V (MAX.) Output ON/OFF control function Overvoltage/overcurrent protection circuits Soft start function	1	6 (Series connection)		*1	0	2.7 to 5.5	250*2	1.2 M	USB-6
PQ7L2020BP▲	White LED driver for backlight (for small panels)	 High voltage CMOS output: 37 V (MAX.) Output ON/OFF control function Overvoltage/overcurrent protection circuits Soft start function Possible to use a low-capacity (0.1 µF) output capacitor 	1	9 (Series connection)	PWM	*1	0	2.9 to 5.5	500	1.0 M	USB-6
IR2E58U		 Capable of driving a maximum of 96 LEDs with 12 LEDs (in series) per channel Built-in step-up DC-DC converter High oscillation frequency (1.5 MHz) makes use of a small coil possible Capable of controlling brightness using PWM control Step-up output control according to LED-Vf 	8	96		0	0	4.5 to 28	40/ch	500 k to 1.5 M	24HQFN
IR2E65U	for backlight	 Capable of driving a maximum of 120 LEDs with 12 LEDs (in series) per channel Built-in step-up DC-DC controller High oscillation frequency (1.5 MHz) makes use of a small coil possible Wider range of PWM brightness control possible, from simultaneous total output control to local dimming Step-up output control according to LED-Vf 	10	120	PWM	0	External	10 to 28	100/ch	500 k to 1.5 M	52HQFN
☆IR2E71Y	LED driver for backlight and call alert display (auto brightness adjustment)	 2 ch (11 LEDs x 2 ch) LED driver for backlight Auto brightness adjustment backlight LED 6 ch RBG LED driver for illumination Built-in switching regulator for LCD backlight Built-in LCD controller power supply (+5.8 V / -5.8 V MAX.) LDO 1 ch Interface for digital-output proximity sensor with ambient light sensor Built-in general purpose input/output port (7 ch MAX.) 	Backlight 2 RGB 6	Backlight 22 RGB 6	PWM	0	0	3.0 to 4.5	Backlight 25.5/ch RGB 12.7/ch	10 k to 1 M	35WL-CSP

*1 LED constant current value can be set by external resistors.

*2 Peak switching current *3 Constant current (MAX.)

The model marked with ▲ may not be available in the near future. Contact with SHARP for details before use.

Analog

LED DRIVERS

RoHS

•Built-in Step-up Circuit (2)

Model No.	Function	Features	No. of output circuits	Number of LEDs	Booster method	Constant current circuit	Switching transistor	Input voltage range (V)	Output ^{*1} current (mA) MAX.	Oscillation frequency (Hz) TYP.	Package
IR2E67M	White LED driver for backlight	 Built-in 10 ch. constant-current control amplifier (external output transistor) Enables driving LEDs up to external transistor voltage limit Built-in timing controller for lighting Wider range of PWM brightness control possible, from simultaneous total output control to local dimming Step-up output control according to LED-Vf 	10	*2	*3	*4	External	4.5 to 5.5	*5	_	80LQFP- 1420
IR2E70N	White LED driver for backlight	 Built-in step-up DC-DC controller for 2 ch individual control Capable of 2 ch individual PWM brightness control LED current value adjustable by external signal (voltage input / PWM signal) Brightness control possible at high contrast ratio 3000:1 Step-up output control according to LED-Vf 	2	*2	PWM	*6	External	4.5 to 5.5 8 to 28	*5	100 k to 500 k	24SSOP

*1 Constant current (MAX.)
*2 Determined by external transistor voltage limit.
*3 Built-in feedback voltage-generating circuit for external power supply.
*4 Built-in constant-current control amplifier (external output transistor)
*5 Determined by external resistor.

*6 Constant current can be controlled by LED anode voltage control.

Analog/RF

AC-DC CONVERSION TYPE ICs FOR LED LIGHTING / POWER AMPLIFIERS FOR WIRELESS LAN

RoHS

■AC-DC Conversion Type ICs for LED Lighting

Model No	Foaturos	Operating temperature	Supply	Dissipation current	Switching frequency	Gate cap	driver acity	Systom	Packago
woder no.	reatures	range (°C)	(V)	(mA) TYP.	(kHz)*1 TYP.	Low (Ω)	High (mA)	System	Tackage
IR3M92N4	Overvoltage/overheat/overcurrent circuits, high-speed activation, stand-by feature, PWM brightness control	-30 to +100	10 to 18	1	160	MAX. 15	MIN. 40	Flyback Step-down	SOP-8

*1 When operating a flyback converter

■Power Amplifiers for Wireless LAN

Model No.	Application	Supply voltage Vcc (V) TYP.	Control voltage Vbb (V) TYP.	Linear output power ^{*1} (dBm)	Dissipation current (mA) TYP.	Gain (dB) TYP.	Detection circuit	Matching circuit	Package (mm)
IRM068U7	For 2.4 GHz single-band wireless LAN			18	115	27	0	Built-in (IN)	HQFN6 pin
QM2A1UA003	(IEEE802.11b/g/n)		0.0	20	150	28	0	Built-in (IN)	(1.5 × 1.5 × 0.4 mm)
IRM053U7	For 5 GHz single-band wireless LAN	33	2.0	18	170	30	0	Built-in (IN/OUT)	HQFN10 pin
QM2A1UA004	(IEEE802.11a/n)	0.0		20	225	31	0	Built-in (IN/OUT)	$(2 \times 2 \times 0.4 \text{ mm})$
	For 2.4/5 GHz dual-band wireless LAN		20	17	100	28	0	Built-in	HQFN16 pin
111100700	(IEEE802.11a/b/g/n)		2.9	17	140	30		(IN/OUT)	(3 × 3 × 0.4 mm)

*1 At time of OFDM 64QAM modulating wave input.

Analog/RF FRONT-END MODULE FOR WIRELESS LAN

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■Front-End Modules for Wireless LAN

					Tra	nsmitter sectio	n	Receive	er section	
Model No.	Application	Features	Supply voltage (V) TYP.	Control voltage (V) TYP.	EVM (%)/ Output power (dBm)	Dissipation current (mA)/ Output power (dBm)	Gain (dB) TYP.	Noise figure (dB) TYP.	Gain: Normal/ Bypass (dB) TYP.	Package
QM2A1UB028/ 032A	Front-end IC for 2.4 GHz wireless LAN (802.11b/g/n/ac) (SP3T SW + PA + LNA)	Built-in detection circuit, high efficiency / high linear- output power amplifier .11ac-compliant low EVM			2/19*1	200/19	27	2	13/-5.5	HQFN16 pin
QM2A1UB029/ 033A	Front-end IC for 5 GHz wireless LAN (802.11a/n/ac) (SPDT SW + PA + LNA)	 Low-noise amplifier with bypass mode Built-in input/output matching circuit Compact and thin package 	3.6	3.3	2/18 ^{*2}	180/18	28	2.5	13/-7	(2.5 × 2.5 × 0.4 mm)

*1 MCS7 HT20 at 64QAM input *2 MCS7 HT40 at 64QAM input

RoHS

●Lead-Inserting Type Packages [For regulators: PQ series]

Package type	Appearance (Package material)	No. of terminals	Terminal pitch mm	Outline dimensions (Width x Thickness x Height) mm	Lead frame material
ТО-220	(Plastic)	4	2.54	10.2 (MAX.) x 4.5 x 29.1* ²	Cu
TO-220 (Full mold)	(Plastic)	4	2.54	10.2 (MAX.) x 4.5 x 29.1* ²	Cu
TO-220 (Full mold) [Lead forming type]	(Plastic)	5	(1.7)*1	10.2 (MAX.) x 4.5 x 24.6* ²	Cu
TO-220 [Lead forming type]	(Plastic)	5	(1.7)*1	10.2 (MAX.) x 4.5 x 24.6* ²	Cu
TO-220 [Lead forming type]	(Plastic)	5	(1.7)*1	10.2 (MAX.) x 4.5 x 24.6* ²	Cu

 $^{\star}1~$ The figure in parentheses indicates reference value.

*2 Including lead length

•Surface-Mount Type Packages [For regulators/LED drivers: PQ series]

Package type	Appearance (Package material)	No. of terminals	Terminal pitch mm	Outline dimensions (Width x Height x Thickness) mm	Lead frame material
SC-63	(Plastic)	5 (Heat sink included)	(1.27)*1	6.6 (MAX.) x 9.7 (MAX.)*² x 2.1	Cu
SOP-8	(Plastic)	8	1.27	5 x 6.2* ² x 1.55* ²	Cu
SOT-89	(Plastic)	6	1.5	4.5 x 4.3* ² x 1.5	Cu

*1 The figure in parentheses indicates reference value.

*2 Including lead length



•Surface-Mount Type Packages [For regulators/LED drivers: PQ series] (cont'd)

Package type	Appearance (Package material)	No. of terminals	Terminal pitch mm	Outline dimensions (Width x Height x Thickness) mm	Lead frame material
SOT-23-6	(Plastic)	6	0.95	2.9 x 2.8*² x 1.3	Cu
SOT-23-6W	(Plastic)	6	0.95	2.9 x 2.8* ² x 1.3	Cu
SOT-23-L	(Plastic)	6	(0.95)*1	(3.4)*1 x 3.3*2 x 1.4 (MAX.)	Cu
SOT-23-5	(Plastic)	5	(0.95)*1	(2.9)* ¹ x 2.8* ² x 1.3 (MAX.)	Cu
USB-6		6	0.5	2.0 x 1.8 x 0.8	Cu (Terminal material)/ Au plating (Terminal finish)
USB-8	And And	9 (Including radiating fin)	1.0	5.0 x 4.5 x 0.75 (MAX.)	Cu

*1 The figure in parentheses indicates reference value.

*2 Including lead length